

# Two phase CO<sub>2</sub> cooling for Micromegas Modules

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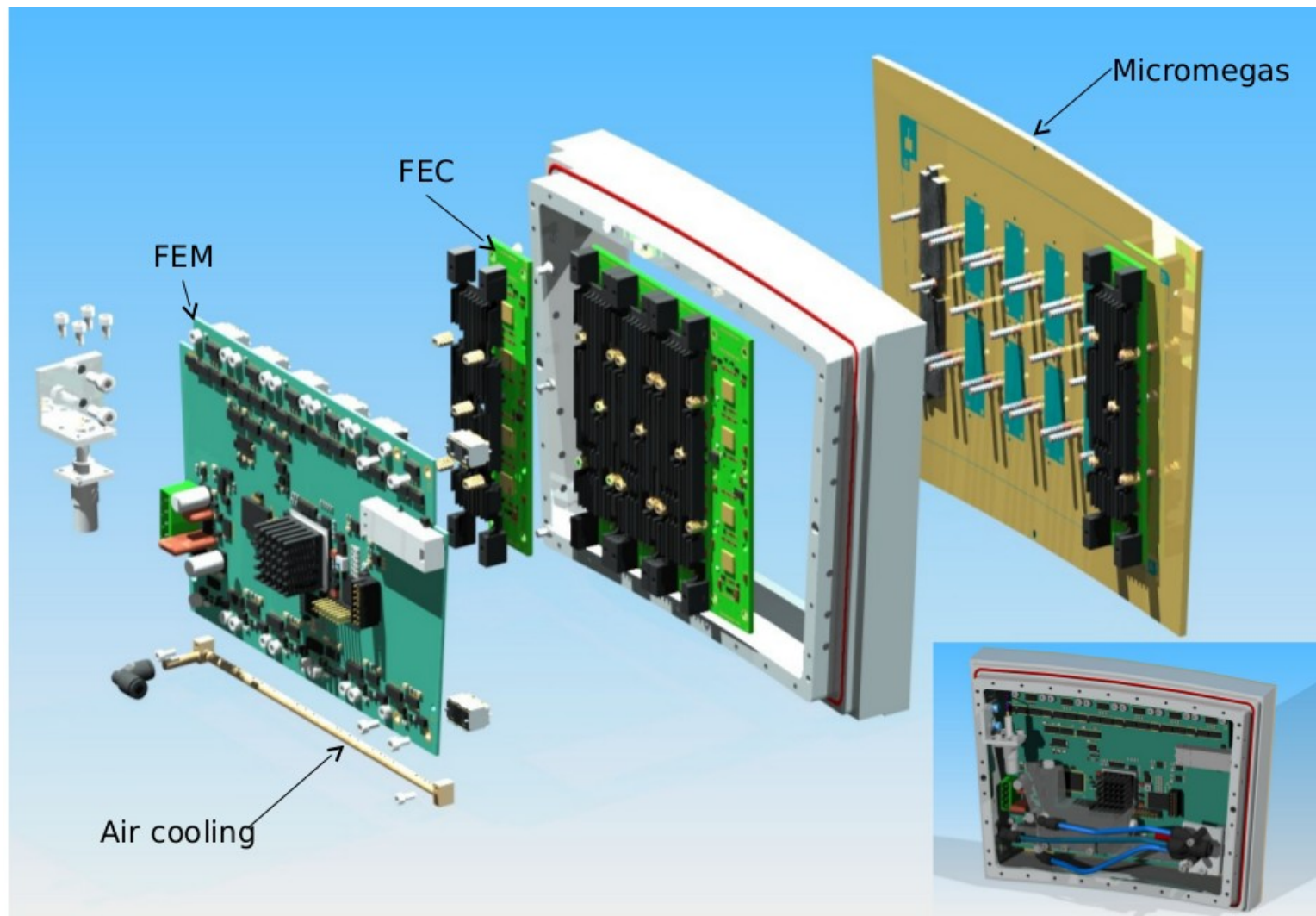
# Overview :

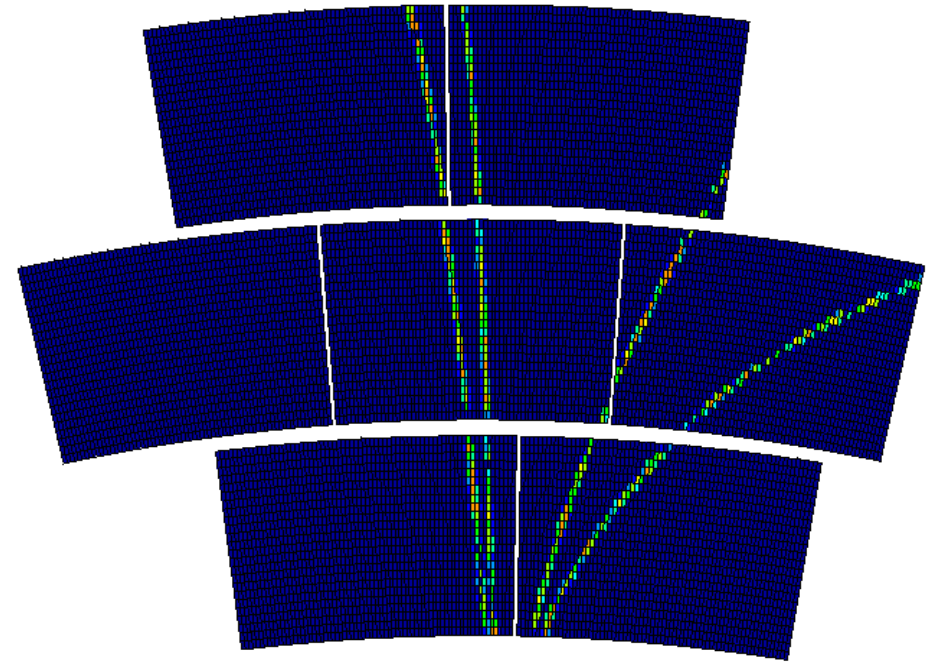
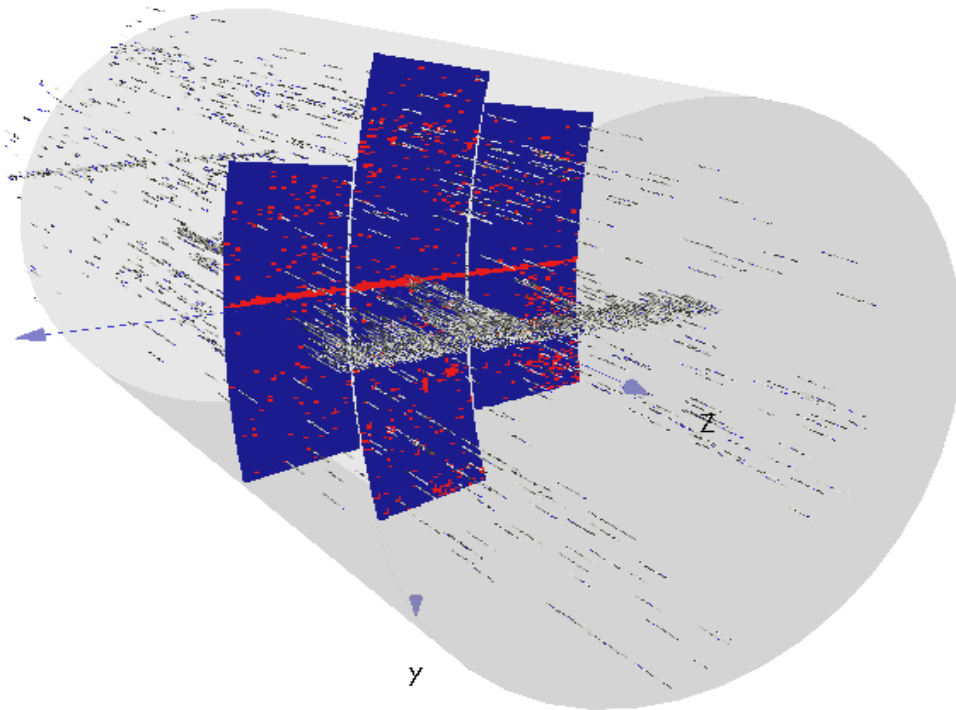
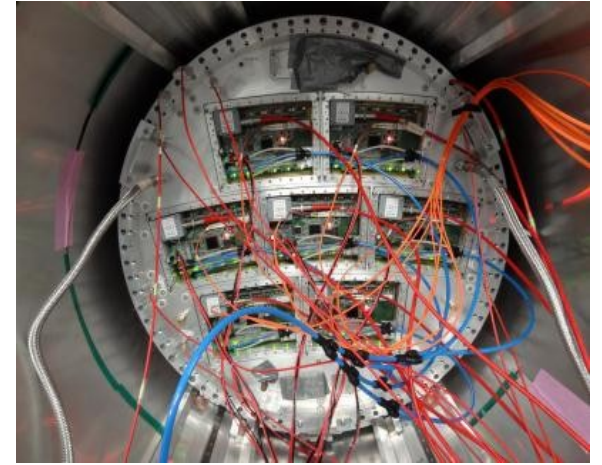
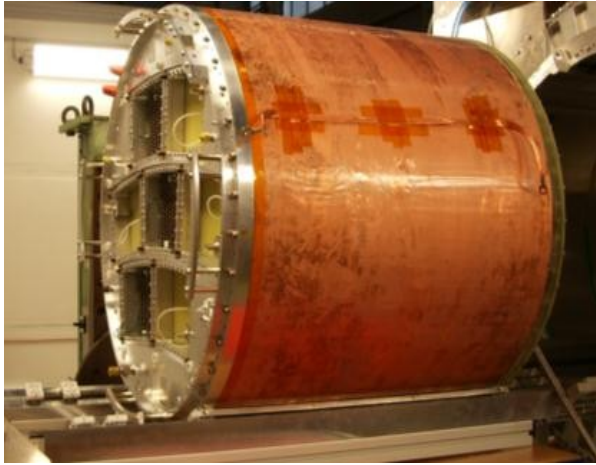
- The electronics
- Large Prototype TPC for ILC
- Requirement for cooling and why CO<sub>2</sub> cooling
- How cooling is done
- Results of cooling
- Future plans

# The AFTER electronics is applied for Micromegas readout

6 FECs, 1 FEM, 24 Chips, 1728 ch

- 24 rows with 72 pads
- 3/7 mm<sup>2</sup> pad
- 1728 pads per module
- resistive foil to spread charge





# Requirement For Cooling

The electronics runs at 5 Volt and consumes power nearly 26 Watts

6 FECs	ASICs = 12 Watts	19 Watts
	Power Regulators = 7 Watts	
FEM		3.5 Watts
FPGA		3.5 Watts
<b>Total</b>		<b>26 Watts</b>

# Requirement For Cooling

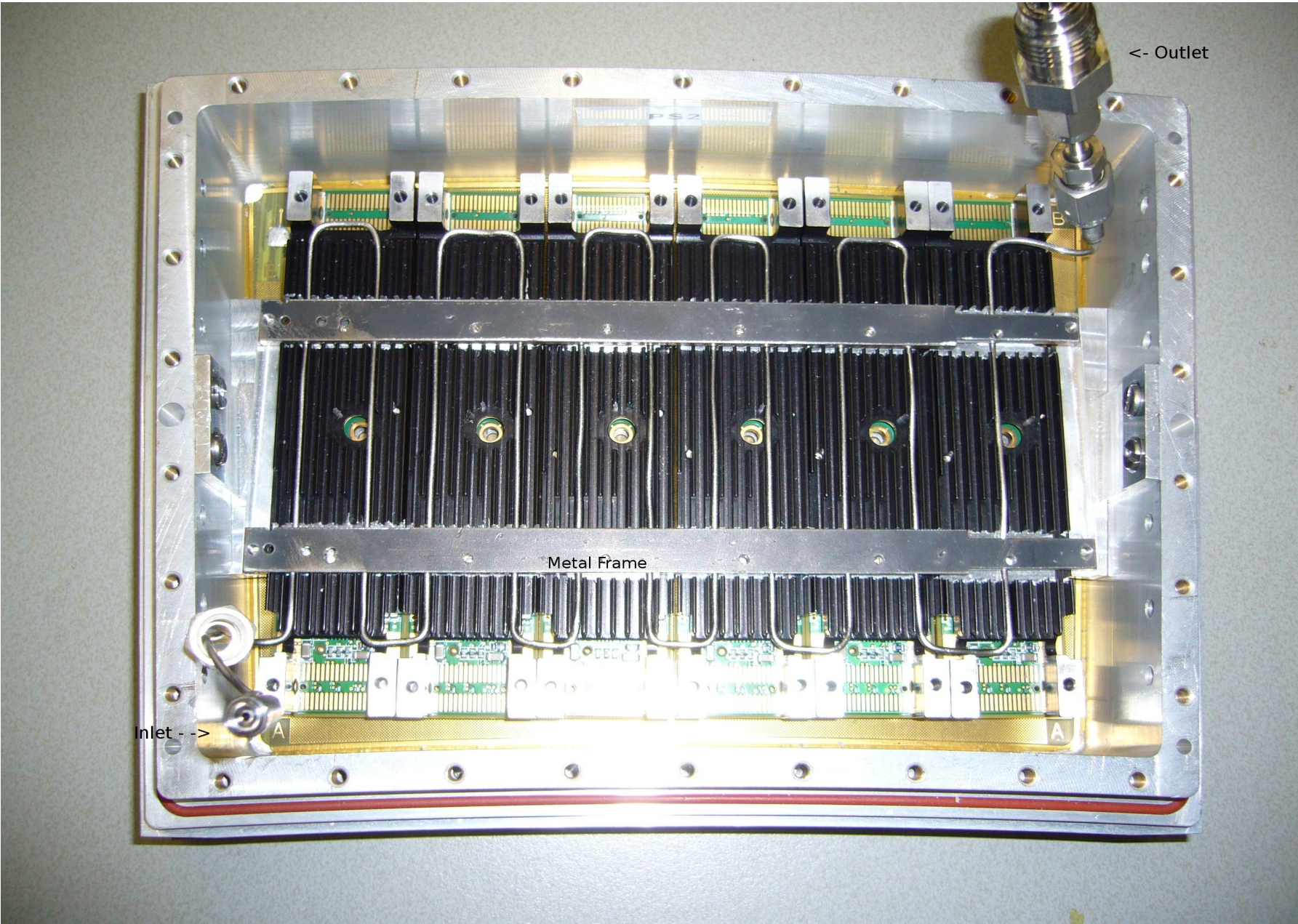
This power consumption rises up temperature of the Module up to 60 degrees

Growth of temperature results in:

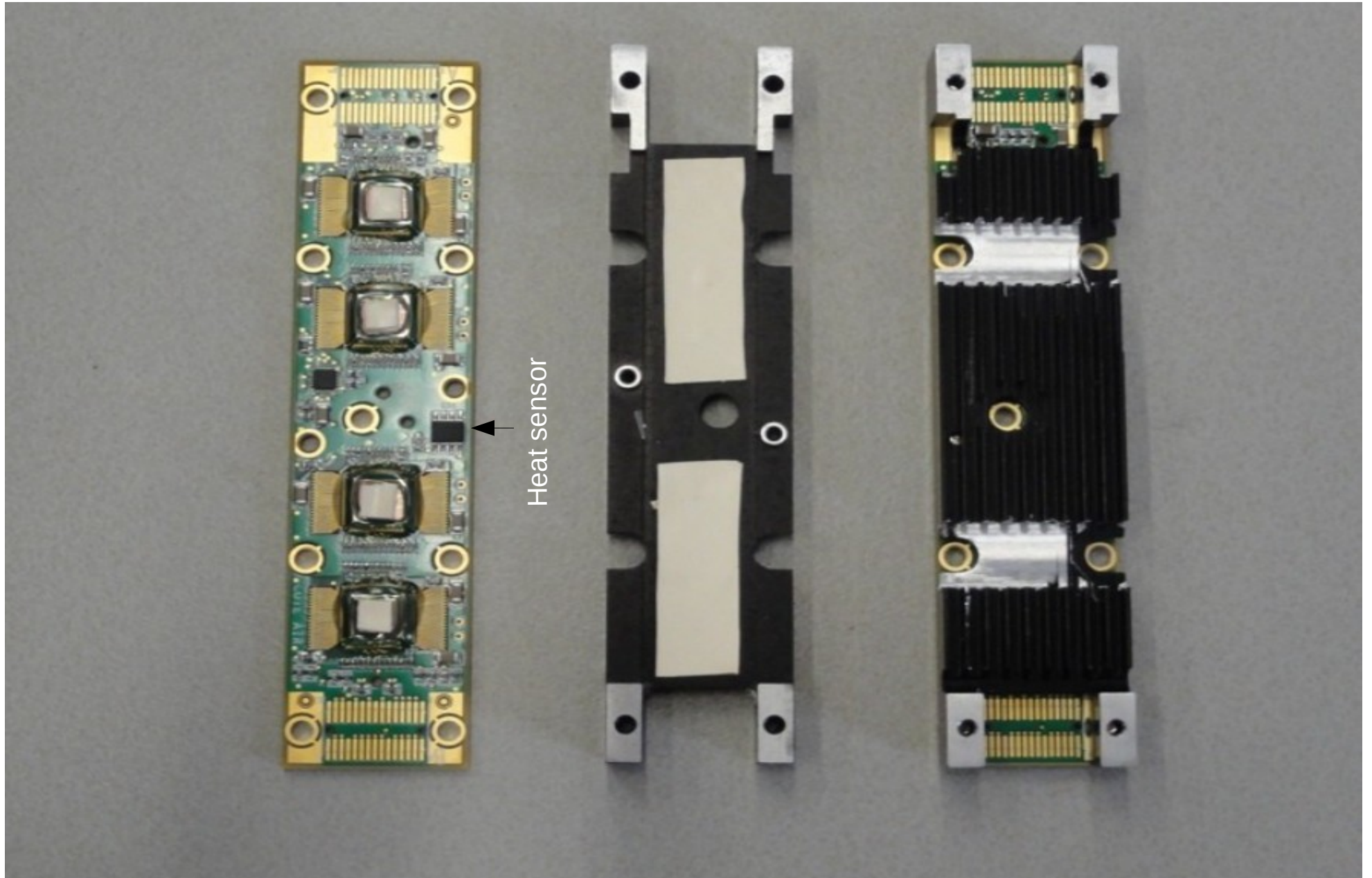
- possibility of damage in electronics, if left running for hours without cooling
- heating up of pad plan  
and hence convection current in TPC gas

Conclusion: 'proper cooling is necessary'

# This Cooling circuit inserted inside the Module

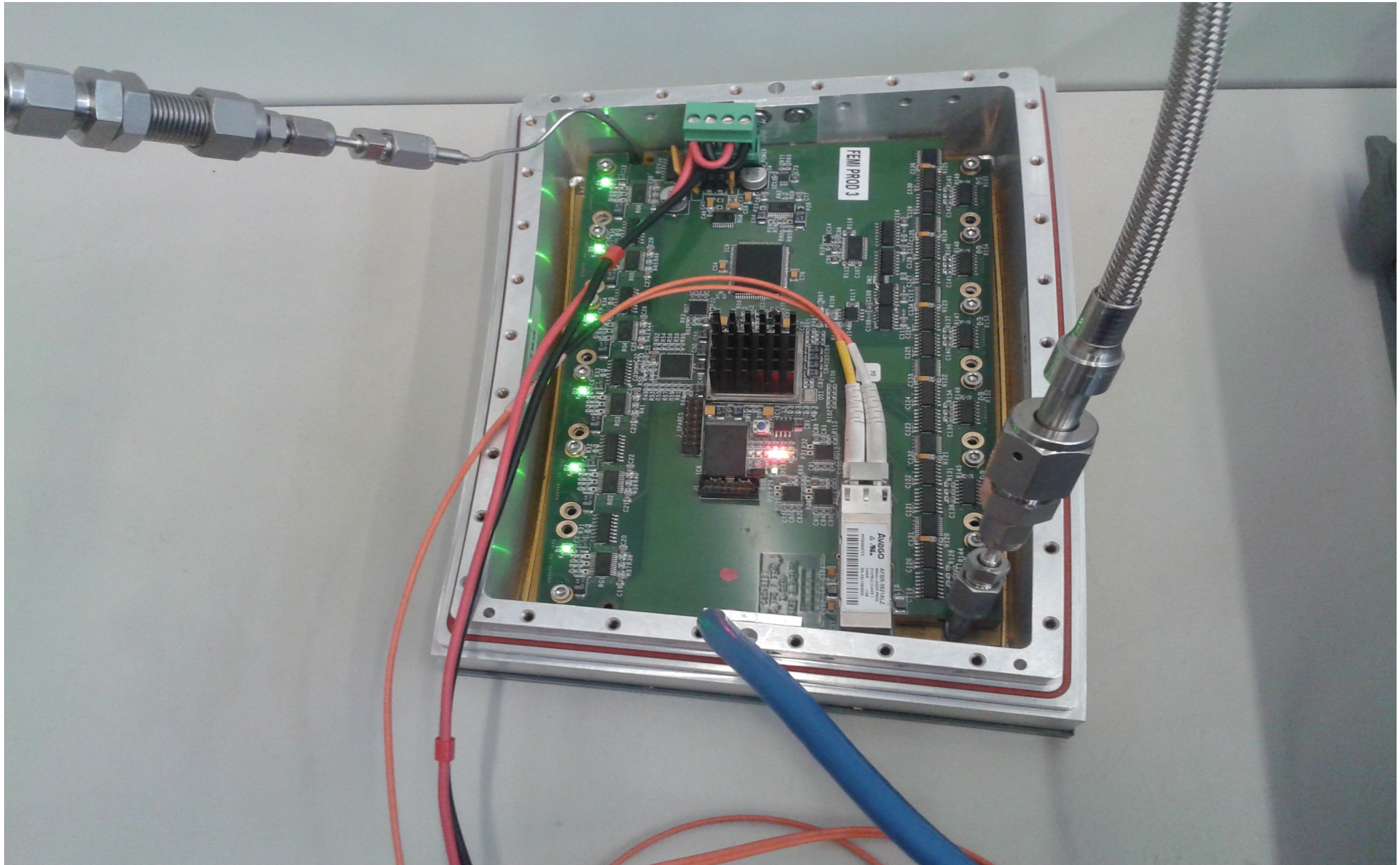


FEC and the Radiator. Each FEC contains one heat Sensor.





A test of the cooling circuit has been carried out at NIKHEF during 02/Dec/2013 to 04/Dec/13



# The CO2 cooling system used at NIKHEF



## At NIKHEF



# Transportable Refrigeration Apparatus for CO<sub>2</sub> Investigation

or

**'TRACI'**

(Purchased by KEK)

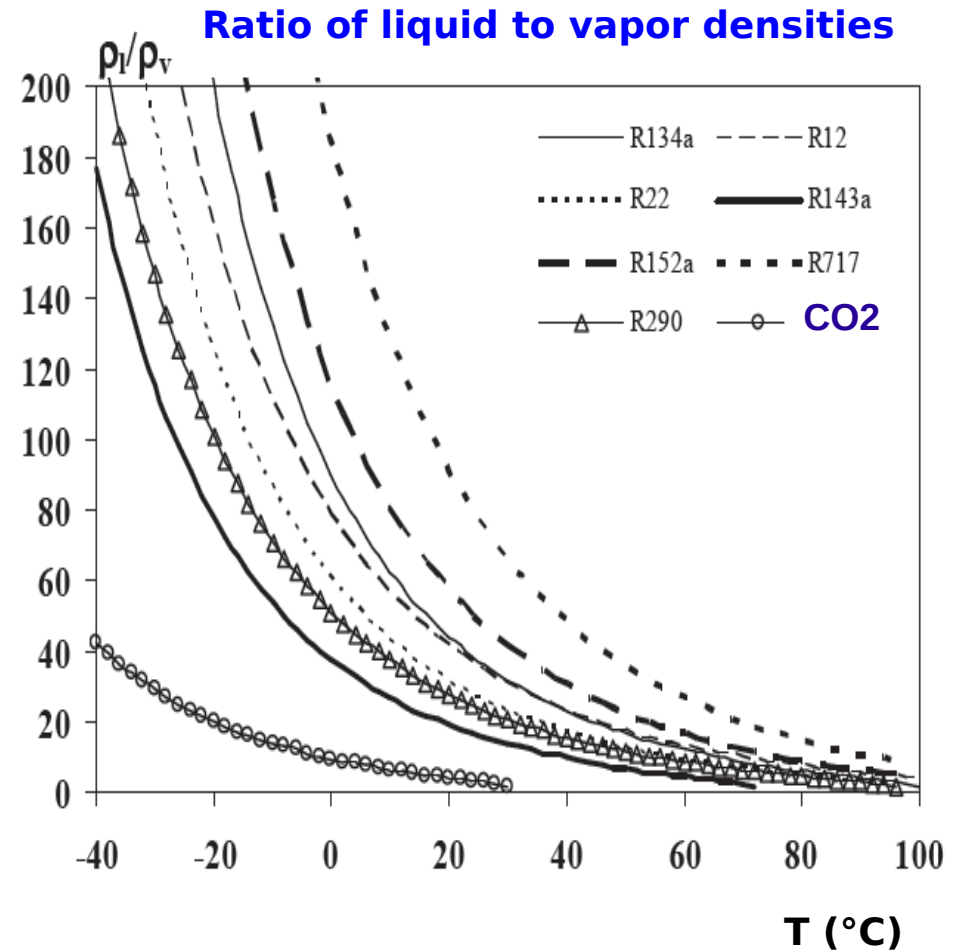
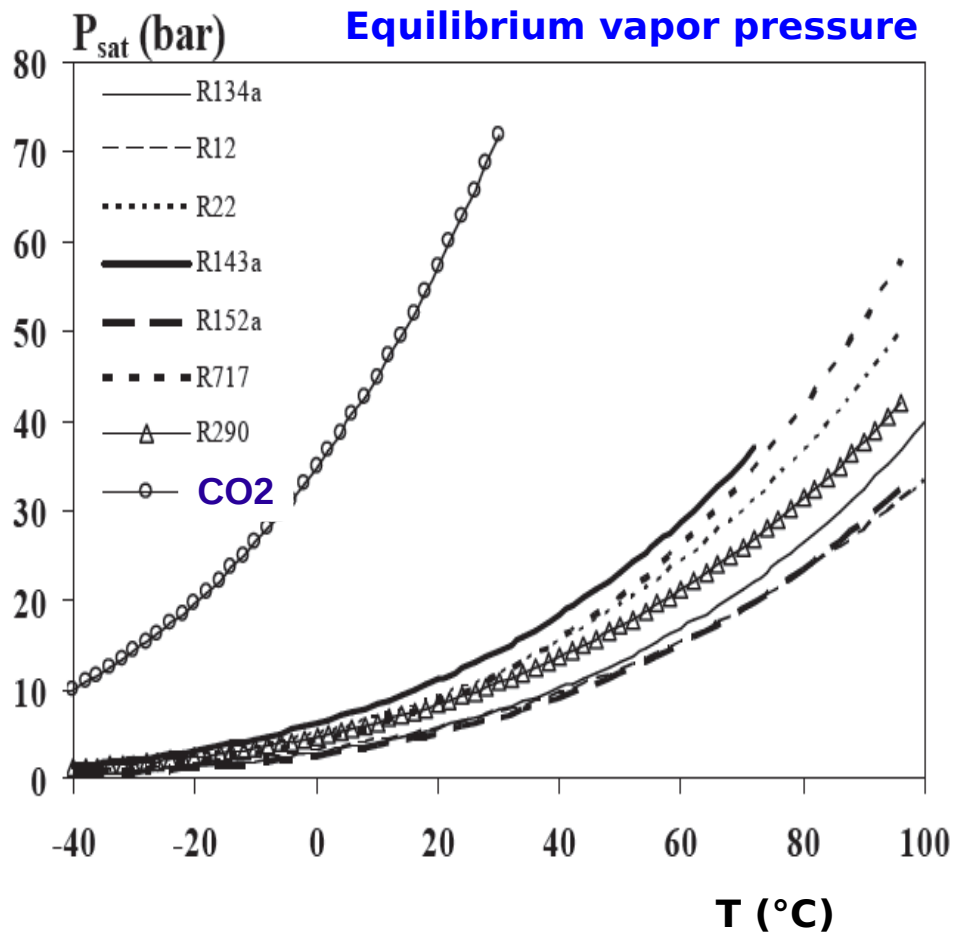
## **Can Circulate Liquid CO<sub>2</sub>**

- at different pressures, hence, at different vapor temperatures.
- and at different flow rates.
- cooling power: '100 watts - 250 watts'.
- cooling ranges form “ -40 °C to +20 °C.

## Why CO<sub>2</sub> as a refrigerant ?

Higher slope of the vapor pressure curve means that  $\Delta P$  in the system is smaller.

Low ratio of liquid to gas densities results in a more homogenous two-phase flow (Pettersen 2002).



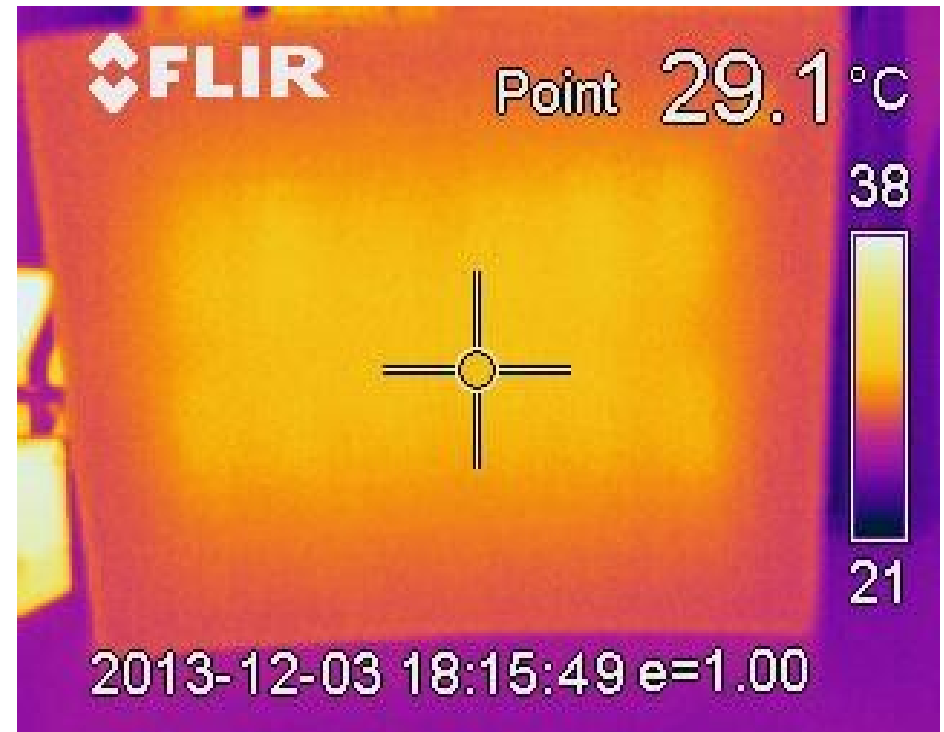
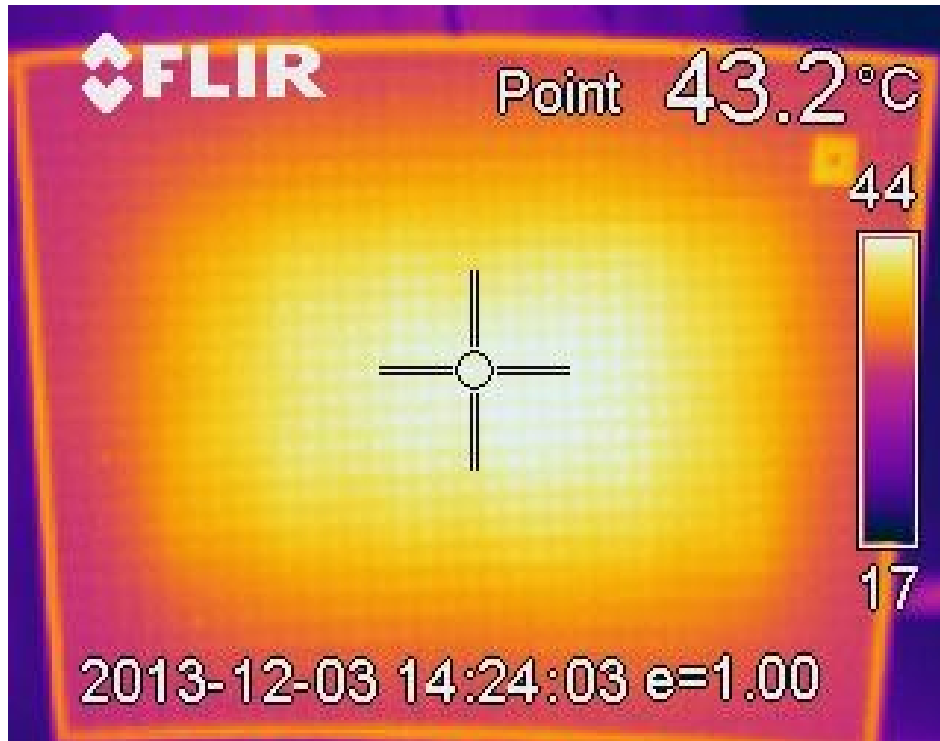


# Temperature difference with and without cooling\*

FECs and FEMI	Temp ( °C) Without cooling	Temp (°C) With cooling
FEC 0	<b>55</b>	<b>35</b>
FEC 1	<b>58</b>	<b>34</b>
FEC 2	<b>61</b>	<b>33.5</b>
FEC 3	<b>62</b>	<b>34.5</b>
FEC 4	<b>60</b>	<b>34</b>
FEC 5	<b>55.5</b>	<b>33.5</b>
FEMI	<b>54.5</b>	<b>37</b>

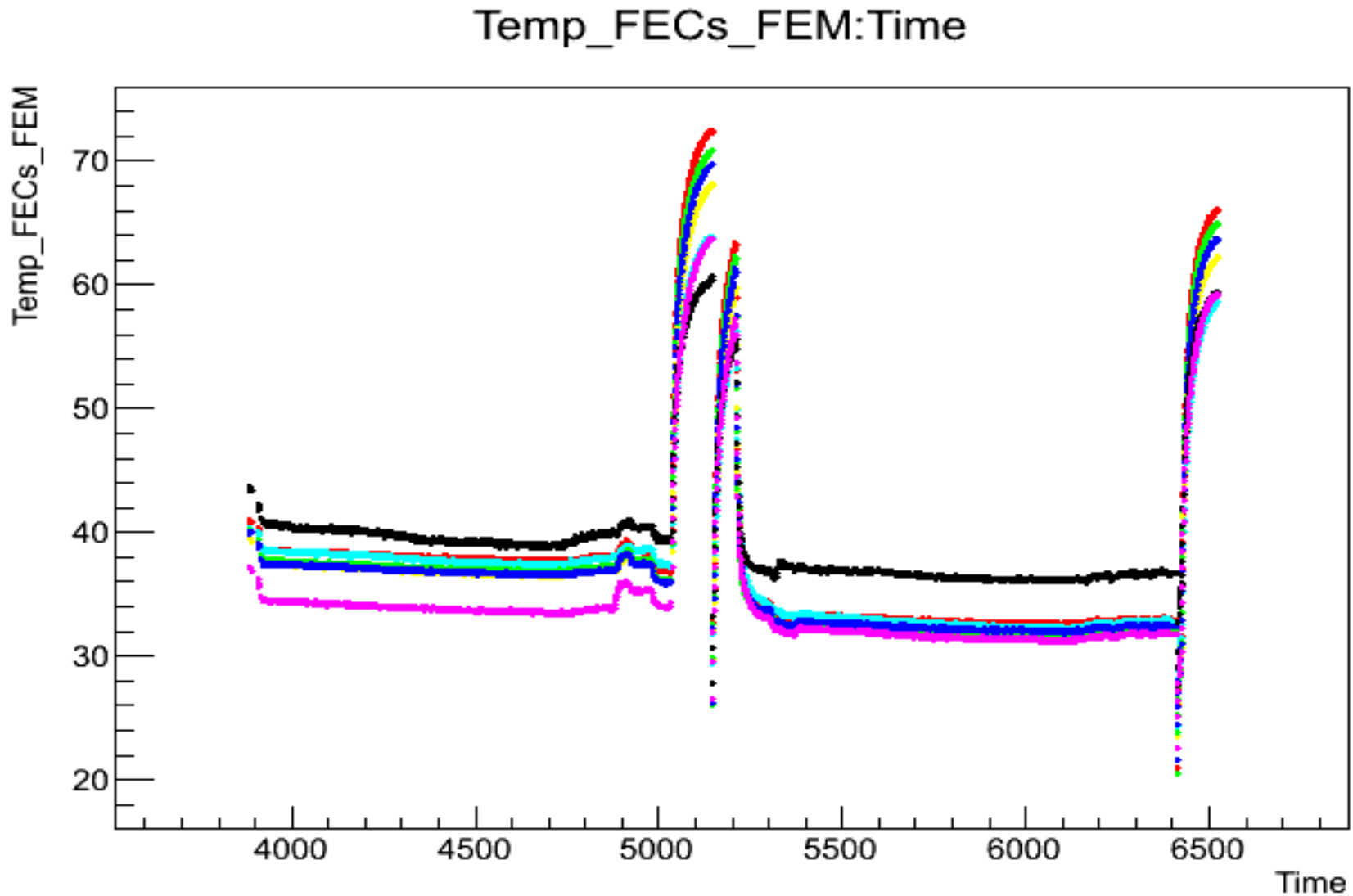
\*At Out-Pressure=45 bar, In-Pressure=55.2 bar, Temp 10.0 °C, Flow rate=2.0 gm/sec

# Infrared images of the module without and without cooling

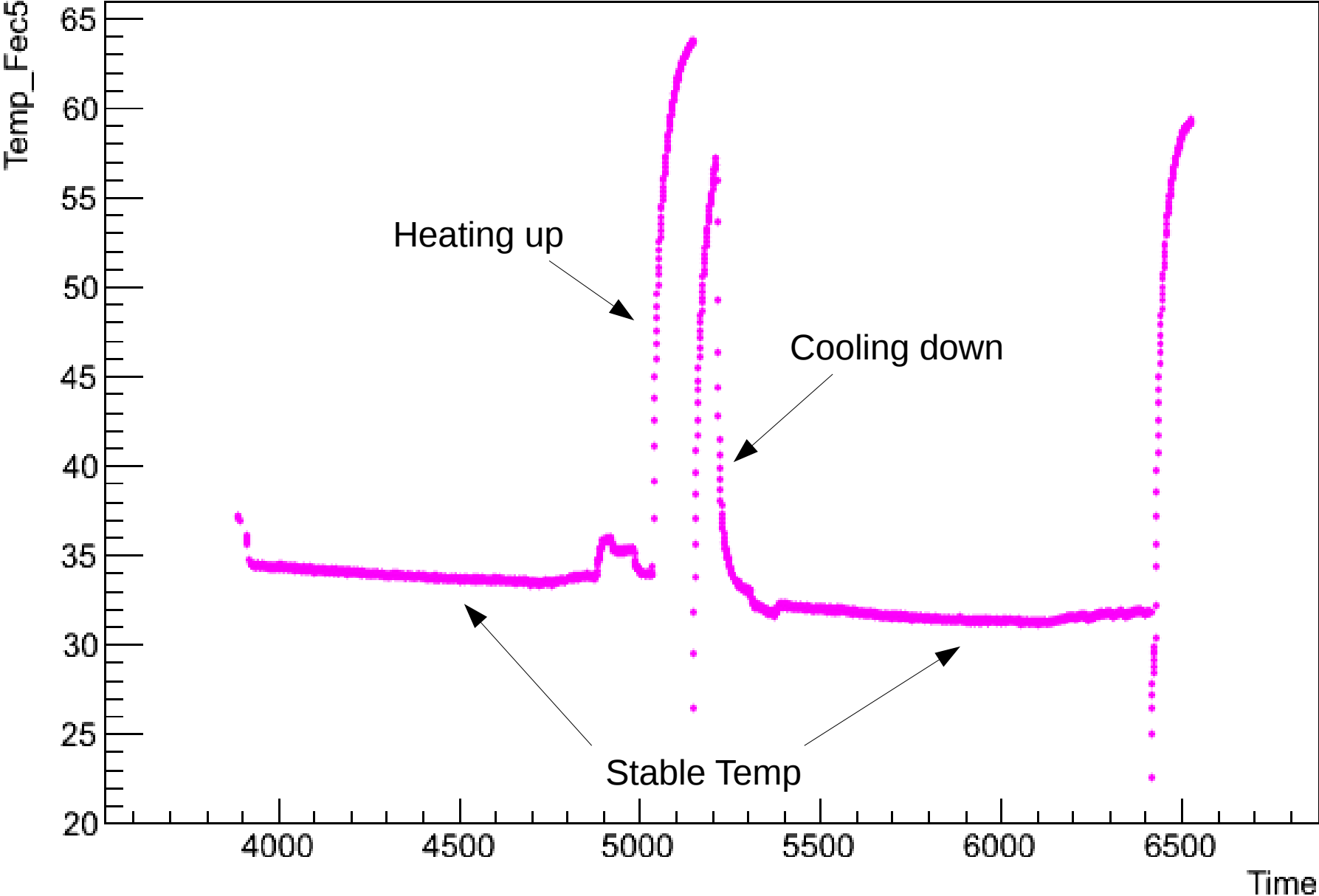




# Temperature profile for all the FECs and the FEMI



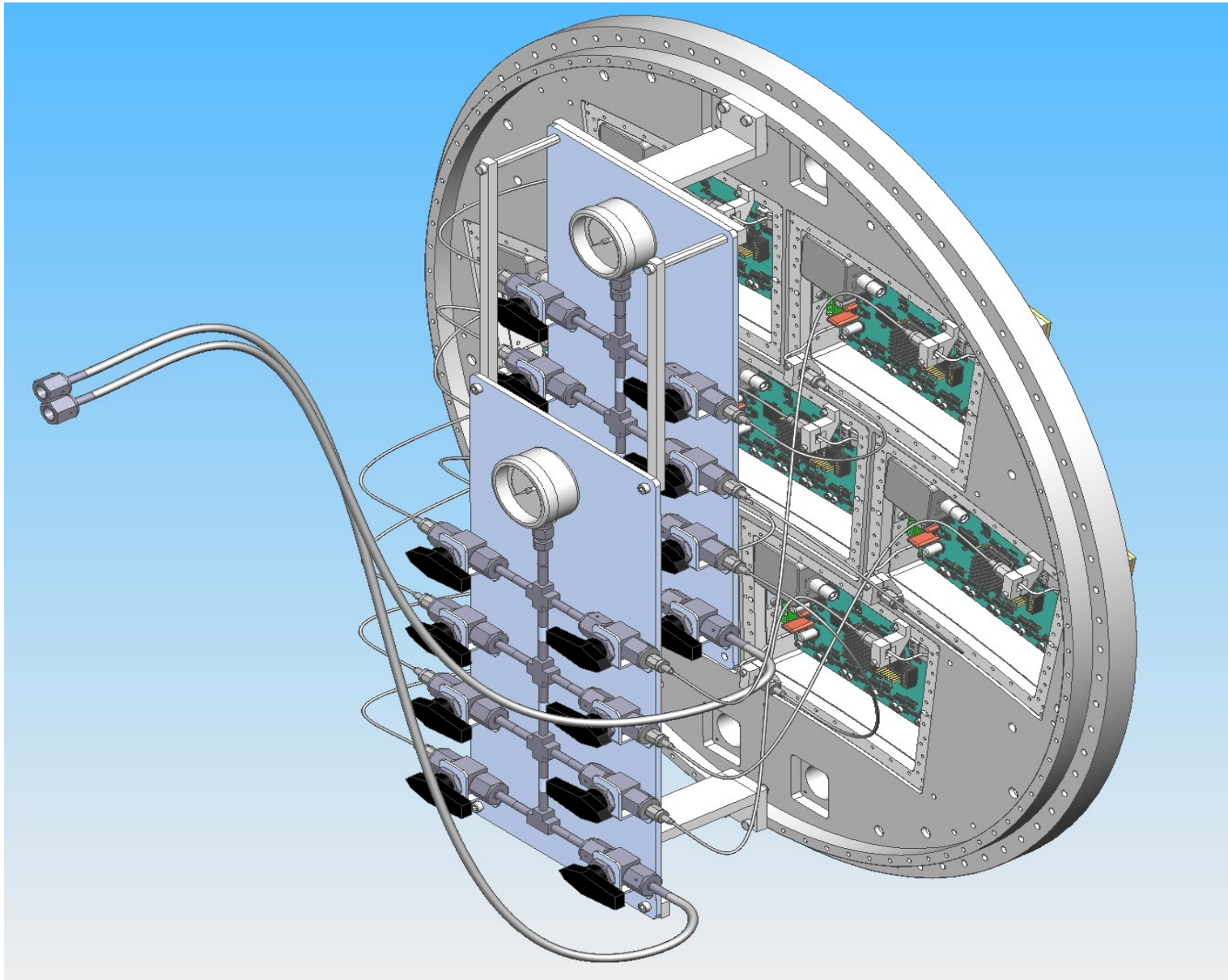
Temp\_Fec5:Time



# Conclusions and future plan

- the temperature profiles show that cooling can stabilize temperature at 31 to 33 degree.
- better thermal contact with the cooling tubes and heat radiators will increase the performance.
- we are planing to apply this cooling model to all 7 modules in parallel for our next data taking at DESY starting from 17 Feb 2014 .

# Future Plan



Thank You

# Back Up Slides

# Temperature vs Drift velocity

**Tmp VS Drift Velocity**

Argon 90 : Methane 10

